Vishay Techno

Thick Film Chip Resistors, High Voltage

FEATURES

- High voltage up to 3000 V
- Outstanding stability < 0.5 %
- Flow solderable
- Custom sizes available
- Automatic placement capability
- Tape and reel packaging available
- Termination style: 3-sided wraparound termination or single termination flip chip standard; 5-sided wraparound termination available
- · Internationally standardized sizes
- Suitable for solderable, epoxy bondable, or wire bondable applications
- Termination material: solder-coated nickel barrier or solder coated non-magnetic terminations standard; gold, palladium silver, platinum gold, platinum silver or platinum palladium gold terminations available
- Multiple styles, termination materials and configurations, allow wide design flexibility
- Epoxy bondable or wire bondable non-magnetic terminations available
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note * This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

STANDARD ELECTRICAL SPECIFICATIONS						
GLOBAL MODEL	CASE SIZE	POWER RATING P _{70 °C} W	MAXIMUM WORKING VOLTAGE ⁽¹⁾ V	RESISTANCE RANGE ⁽²⁾ Ω	TOLERANCE ⁽³⁾ ± %	TEMPERATURE COEFFICIENT ⁽⁴⁾ (-55 °C to +155 °C) ± ppm/°C
CRHV1206	1206	0.30	1500	2M to 100M	0.5	100
				2M to 1G	1, 2, 5, 10, 20	
				1.1G to 8G	2, 5, 10, 20	
CRHV1210		0.45	1750	4M to 100M	0.5	100
	1210			4M to 1G	1, 2, 5, 10, 20	
				1.1G to 10G	2, 5, 10, 20	
CRHV2010	2010	0.50	2000	6M to 100M	0.5	100
				6M to 1G	1, 2, 5, 10, 20	
				1.1G to 10G	2, 5, 10, 20	
				11G to 35G	5, 10, 20	
CRHV2510	2510	0.60	2500	10M to 100M	0.5	100
				10M to 1G	1, 2, 5, 10, 20	
				1.1G to 10G	2, 5, 10, 20	
				11G to 40G	5, 10, 20	
	2512	1.0	3000	10M to 100M	0.5	100
CRHV2512				10M to 1G	1, 2, 5, 10, 20	
				1.1G to 10G	2, 5, 10, 20	
				11G to 50G	5, 10, 20	

Notes

• For non-standard sizes, lower values or higher power rating requirement, contact factory

⁽¹⁾ Continuous working voltage shall be $\sqrt{P \times R}$ or maximum working voltage, whichever is less

⁽²⁾ Resistance values below 1 G Ω are calibrated at 100 V_{DC}, and values of 1 G Ω and above are calibrated at 1000 V_{DC}. Calibration at other voltages available upon request

⁽³⁾ Contact factory for tighter tolerances

⁽⁴⁾ Reference only: not for all values specified. Consult factory for your size and value. The TC for "AA" option is typically 200 ppm

Revision: 19-May-2021

1



HALOGEN

FREE





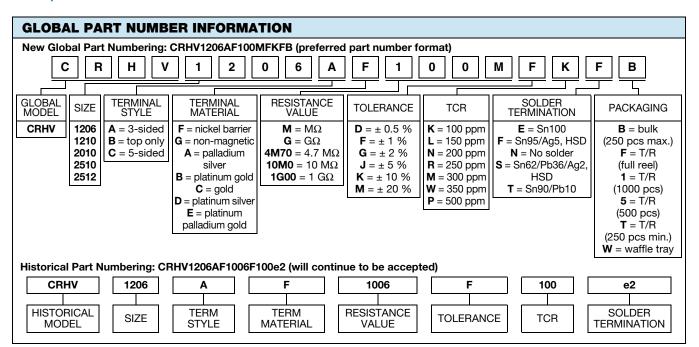
www.vishay.com

LINKS TO ADDITIONAL RESOURCES



www.vishay.com

CRHV Vishay Techno

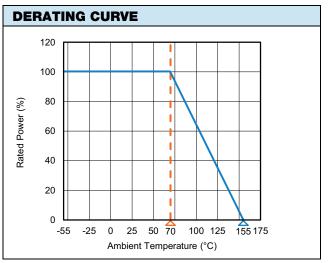


Note

For additional information on packaging, refer to the Surface Mount Resistor Packaging document (www.vishay.com/doc?31543)

MECHANICAL SPECIFICATIONS					
Resistive element	Ruthenium oxide				
Encapsulation	Glass				
Substrate	96 % alumina				
Termination	Solder-coated nickel barrier or solder coated non-magnetic terminations standard. Gold, palladium silver, platinun gold, platinum silver, platinum palladium gold terminations available.				
Solder finish	Pure tin or tin/lead solder alloys standard. Tin/silver or tin/lead/silver solder alloys available.				

ENVIRONMENTAL SPECIFICATIONS				
Operating temperature	-55 °C to +155 °C			
Life	Less than 0.5 % change when tested at full rated power			
Short time overload	Less than 0.5 % ΔR			



Note

 Reference only: Not for all values specified. Consult factory for your size and value

VOLTAGE COEFFICIENT OF RESISTANCE CHART					
SIZE	SIZE VALUE (Ω)		FURTHER INSTRUCTIONS		
CRHV1206	2M to 199M	25	Values over 200M, consult factory		
CRHV1210	4M to 200M	25	Values over 200M, consult factory		
CRHV2010	6M to 99M	15	Values over 1G, consult factory		
	100M to 1G	20	values over TG, consult factory		
CRHV2510	10M to 99M	10	Values over 10. sensult featers		
	100M to 1G	15	Values over 1G, consult factory		
CRHV2512	10M to 999M	10	Values over EC, consult factory		
	1G to 5G	25	Values over 5G, consult factory		

Revision: 19-May-2021

2

Document Number: 68002

For technical questions, contact: <u>te1resistors@vishay.com</u>

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishav.com/doc?91000

VISHAY, www.vishay.com

CRHV

Vishay Techno

DIMENSIONS IN INCHES (INIMITIETERS)				
Termination Style A	Termination Style B			
(3-sided wraparound) W U U U U U U U U U U U U U U U U U U	(Top conductor only) V U U U U U U U U U U U U U			
Termination Style C (5-sided wraparound)	MODEL	LENGTH (L) ± 0.006 (0.152)	WIDTH (W) ± 0.006 (0.152)	THICKNESS (T) ± 0.002 (0.051)
w	CRHV1206	0.125	0.063	0.025
	CRHV1210	0.125	0.100	0.025
	CRHV2010	0.200	0.100	0.025
0.025 (0.635)	CRHV2510	0.250	0.100	0.025
max.	CRHV2512	0.250	0.126	0.025

ТҮРЕ	TERMINATION MATERIAL	TERMINATION STYLE	TERMINATION STYLE / MATERIAL CODE	SOLDER TERMINATION CODE	
Solderable		3-sided (wraparound)	AF		
	Nickel barrier	Top only (flip chip)	BF	E or T (standard); F or S (optional) ⁽³⁾	
		5-sided (wraparound)	CF		
	Non mognetic	3-sided (wraparound)	AG	E or T (standard);	
	Non-magnetic	Top only (flip chip)	BG	F or S (optional) (3)	
		3-sided (wraparound)	AE		
Epoxy bondable / solderable	Platinum palladium gold	Top only (flip chip)	BE	N (standard); F or S (optional) ⁽¹⁾	
Solderable		5-sided (wraparound)	CE		
MC as here also here (3-sided (wraparound)	AC		
Wire bondable / Epoxy bondable	Gold	Top only (flip chip)	BC	N	
		5-sided (wraparound)	CC		
		3-sided (wraparound)	AA		
Epoxy bondable	Palladium silver ⁽²⁾	Top only (flip chip)	BA		
		5-sided (wraparound)	CA		
		3-sided (wraparound)	AB	1	
	Platinum gold	Top only (flip chip)	BB	N	
		5-sided (wraparound)	СВ		
		3-sided (wraparound)	AD		
	Platinum silver	Top only (flip chip) BD			
		5-sided (wraparound)	CD		

Notes

⁽¹⁾ Use solder termination N for applications requiring epoxy bondable mounting, and solder terminations F or S for applications requiring solderable mounting

(2) While not recommended, palladium silver terminations could be used for solderable applications when using a solder alloy containing silver. If the solder paste being used to solder the palladium silver terminated parts to the boards does not have a silver-based composition, then the silver in the terminations could begin to leach when it is exposed to liquidus non-silver-based solders, causing the potential for solderability and/or solder joint issues

(3) Standard solder plating for the nickel barrier and non-magnetic parts is solder terminations E or T. Hot solder dipped terminations F or S are also available

PERFORMANCE TEST RESULTS TEST CONDITIONS OF TEST (TYPICAL TEST LOTS) Life MIL-STD-202, method 108, 1000 h rated power at +70 °C ≤ ± 0.5 % High temperature exposure MIL-STD-202, method 108 ≤±0.2 % Low temperature operation MIL-PRF-55342, paragraph 4.8.5 $\leq \pm 0.05$ % Resistance to bonding exposure MIL-STD-202, methods 210 $\leq\pm$ 0.1 % Moisture resistance MIL-PRF-55342, paragraph 4.8.9 $\leq \pm 0.06\%$ Solder mounting integrity MIL-PRF-55342, paragraph 4.8.13, 2 kg for 30 s No evidence of mechanical damage Solderability MIL-STD-202, method 208 95 % coverage

Note

This summary is based on testing done on values up to 2 GΩ



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.